Description

The CR range of protectors are based on the proven technology of the T10 thyristor product. Designed for transient voltage protection of telecommunications equipment, it provides higher power handling than a conventional avalanche diode (TVS) and when compared to a GDT offers lower voltage clamping levels and infinite surge life.

Packaged in a transfer moulded DO-214AA surface mount outline designed for high speed pick & place machines used in today's surface mount assembly lines.

Electrical Characteristics

The electrical characteristics of an CRXXXX device is similar to that of a self gated Triac, but the CR is a two terminal device with no gate. The gate function is achieved by an internal current controlled mechanism.

Like the T.V.S. diodes, the CRXXXX has a standoff voltage (Vrm) which should be equal to or greater than the operating voltage of the system to be protected. At this voltage (Vrm) the current consumption of the CRXXXX is negligible and will not effect the protected system.

When a transient occurs, the voltage across the CRXXXX will increase until the breakdown voltage (Vbr) is reached. At this point the device will operate in a similar way to a T.V.S. device and is in an avalanche mode.

The voltage of the transient will now be limited and will only increase by a few volts as the device diverts more current. As this transient current rises, a level of current through the device is reached (lbo) which causes the device to switch to a fully conductive state such that the voltage across the device is now only a few volts (Vt). The voltage at which the device switches from the avalanche mode to the fully conductive state (Vt) is

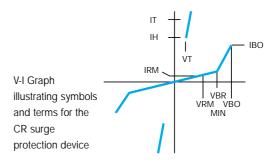
known as the Breakover Voltage (Vbo). When the device is in the Vt state, high currents can be diverted without damage to the CRXXXX due to the low voltage across the device, since the limiting factor in such devices is dissipated power (V x I).

Resetting of the device to the non conducting state is controlled by the current flowing through the device. When the current falls below a certain value, known as the Holding Current (Ih), the device resets automatically.

As with the avalanche T.V.S. device, if the CRXXXX is subjected to a surge current which is beyond its maximum rating, then the device will fail in short circuit mode, this ensures that the equipment is ultimately protected.

Selecting A CRXXXX

- 1. When selecting an CRXXXX device, it is important that the Vrm of the device is equal to or greater than the operating voltage of the system.
- 2. The minimum Holding Current (Ih) must be greater than the current the system is capable of delivering otherwise the device will remain conducting following a transient condition.



The CRXXXX Range Can Be Used To Protect Against Surges As Defined In The Following International Standards.

			SA	SB	SC
FCC Rules Part 68/D	Metallic	10/560µs	50A	100A	100A
	Longitudinal	10/160µs	100A	150A	200A
Bellcore Specification	TR-NWT-001089	10/1000µs	37A	75A	100A
		2/10µs	-	_	500A
		100v/µs	1KV	1KV	1KV
ITU K-17 (Formerly CCITT)	Voltage Wave Form	10/700µs	-	1.5KV	1.5KV
	Current Wave Form	5/310µs	_	38A	38A
VDE 0433	Voltage Wave Form	10/700µs	-	2KV	4.0KV
	Current Wave Form	5/310µs	-	50A	100A
C-NET 131-24	Voltage Wave Form	0.5/700µs	1.0KV	1.0KV	4.0KV
	Current Wave Form	0.8/310µs	25A	25A	100A
IEC 1000 -4-5 (Discharge	through 2Ω impedance) I	8/20µs	-	100A	250A
	Voltage Wave Form	1-2/50µs	_	300V	500V
ITU K-20	Voltage Wave Form	10/700µs	1000V	1000V	4000V
(Formerly CCITT)	Current Wave Form	5/310µs	25A	25A	100A

Specifications

SYMBOL PARAMETER

Electrical Characteristics (Tj = 25°C)

	SYMBOL	PARAIN	<u>ILIER</u>						
	V _{RM}	Stand-o	ff Voltage		Irm	Stand-off C	`urront		
		Stand-off Voltage							
	VBR	Breakdown Voltage			IBO Breakover (Current		
	VBO	Breakov	Breakover Voltage		lн	Holding Current			
	VT	On-Stat	e Voltage						
	• •	On Otal	o voltago						
	THEDMAN	DATA						\/A <u> </u>	LINIT
	<u>THERMAL</u>	DATA						<u>VALUE</u>	<u>UNIT</u>
	Ticta	Storago	and Opera	ting lunction	Tomporatura	Danga		40 to +150	°C
	T stg	Storage and Operating Junction Temperature Range							
	Tj							150	°C
	TL	Maximum Temperature For Soldering				230	°C		
		(For period of 10 seconds max)							
	.								
	Stock	Device	Reverse	Maximum	Maximum	Maximum	Maximum	Maximum	Typical
	Number	Code	Stand-off	Reverse	Breakover	Breakover	Holding	On-State	Capacitance
			Voltage	Leakage	Voltage	Current	Current	_	@1MHz 2v bias
				μΑ	@Ibo	mA	mA	@1A	pF
MAXIMUM RATINGS	CR 0300 SA	030A	25	5	40	800	150	5	100
SUFFIX SA	CR 0640 SA		58	5	77	800	150	5	60
	CR 0720 SA		65	5	88	800	150	5	60
lpp 10x160µs Amps 100	CR 0800 SA		75	5	98	800	150	5	60
lpp 10x560µs Amps 50	CR 1100 SA		90	5	130	800	150	5	60
I _{TSM} 60Hz Amps 20	CR 1300 SA		120	5	160	800	150	5	40
dl/dt Amps/µs 500	CR 1500 SA		140	5	180	800	150	5	40
	CR 1800 SA	180A	160	5	220	800	150	5	40
MAXIMUM RATINGS	CR 2300 SA	230A	190	5	260	800	150	5	30
SUFFIX SB	CR 2600 SA	260A	220	5	300	800	150	5	30
lpp 10x160µs Amps 150	CR 3100 SA	310A	275	5	350	800	150	5	30
Ipp 10x560µs Amps 100	CR 3500 SA	350A	320	5	400	800	150	5	30
I _{тsм} 60Hz Amps 30	CR 0300 SB	030B	25	5	40	800	150	5	100
dl/dt Amps/µs 500	CR 0640 SB	064B	58	5	77	800	150	5	60
αι/ατ / προ/μο	CR 0720 SB		65	5	88	800	150	5	60
	CR 0800 SB		75	5	98	800	150	5	60
	CR 1100 SB		90	5	130	800	150	5	60
	CR 1300 SB		120	5	160	800	150	5	40
	CR 1500 SB		140	5	180	800	150	5	40
	CR 1800 SB		160	5	220	800	150	5	40
	CR 2300 SB		190	5	260	800	150	5	30
	CR 2600 SB		220	5	300	800	150	5	30
	CR 3100 SB		275	5	350	800	150	5	30
	CR 3500 SB		320	5	400	800	150	5	30
MAXIMUM RATINGS SUFFIX SC	CR 0300 SC CR 0640 SC		25 58	5 5	40 77	800 800	150 150	5 5	200 120
SUFFIX SC	CR 0040 SC		65		88	800	150		120
lpp 2x10µs Amps 500	CR 0720 SC		75	5 5	98	800	150	5 5	120
lpp 10x160µs Amps 200	CR 1100 SC		90	5 5	130	800	150	5 5	120
lpp 10x560µs Amps 100	CR 1300 SC		120	5	160	800	150	5	80
I _{TSM} 60Hz Amps 60	CR 1500 SC		140	5	180	800	150	5	80
dl/dt Amps/µs 500	CR 1800 SC		160	5	220	800	150	5	80
	CR 2300 SC		190	5	260	800	150	5	60
	CR 2600 SC		220	5	300	800	150	5	60
	CR 3100 SC		275	5	350	800	150	5	60

320 5

400

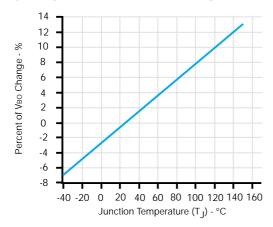
800

150

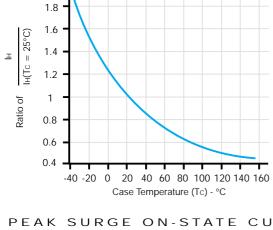
CR 3500 SC 350C

60

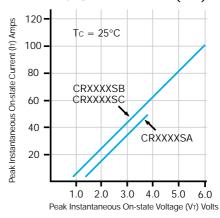
TYPICAL VBO CHANGE VS JUNCTION TEMPERATURE



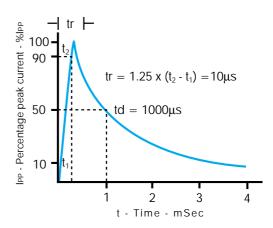
TYPICAL DC HOLDING CURRENT VS CASE TEMPERATURE



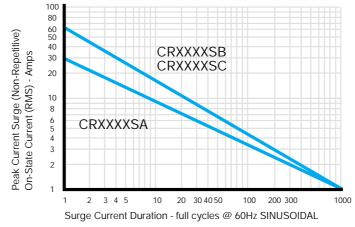
ON-STATE VOLTAGE (V_T) VS ON-STATE CURRENT (I_T)



PULSE WAVE FORM (10/1000µS)



PEAK SURGE ON-STATE CURRENT VS SURGE CURRENT DURATION



10x160µs PULSE WAVE FORM

10x560µs PULSE WAVE FORM

